

## HDSM-281x/283x

### 0.28 in. (7.0 mm) Single-Digit Surface-Mount LED Display

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#### Description

The Broadcom<sup>®</sup> HDSM-281x/283x is a single-digit display of 0.28 in. (7.0 mm) height. This device uses AlInGaP/GaAs chips and has a grey top surface with white segments.

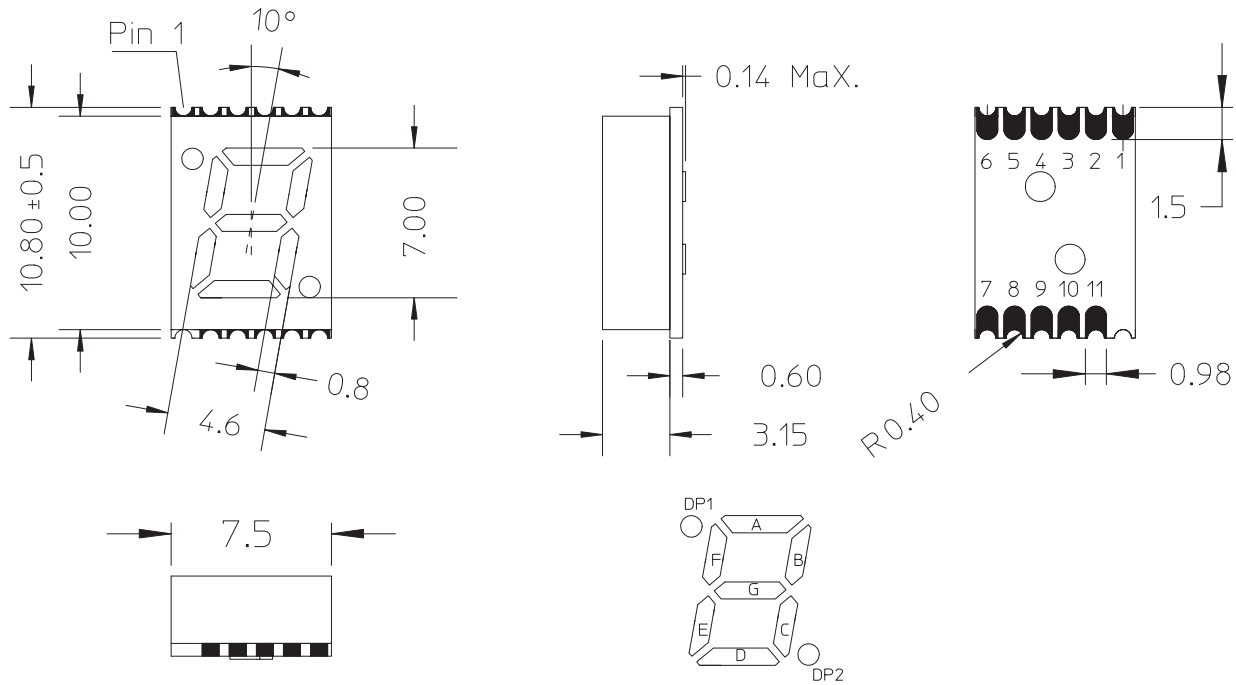
#### Features

- 0.28 in. digit height
- Low current operation
- Excellent characters appearance
- Available in CA and CC
- 1000 pieces per reel
- Moisture sensitivity level: Level 3
- RoHS compliant

#### Ordering Information

Red	Green	Yellow	Orange	Description
HDSM-281C	HDSM-281H	HDSM-281F	HDSM-281L	Common Anode, Upper and Lower Decimal
HDSM-283C	HDSM-283H	HDSM-283F	HDSM-283L	Common Cathode, Upper and Lower Decimal

# Package Dimensions



**NOTE:**

1. All dimensions are in millimeters (inches).
2. Tolerance  $\pm 0.25$  mm (0.01 in.) unless otherwise noted.

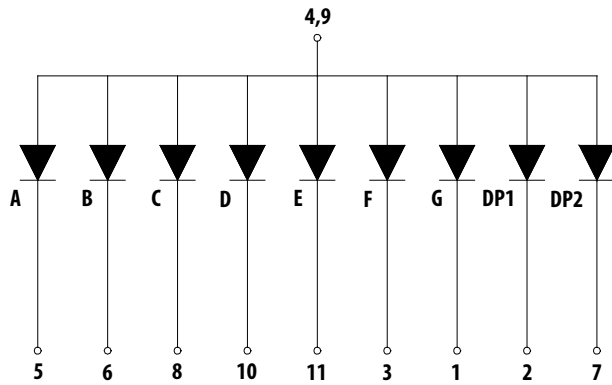
### Pin Connection (Common Anode)

Pin Number	Connection
1	CATHODE G
2	CATHODE DP1
3	CATHODE F
4	COMMON ANODE
5	CATHODE A
6	CATHODE B
7	CATHODE DP2
8	CATHODE C
9	COMMON ANODE
10	CATHODE D
11	CATHODE E

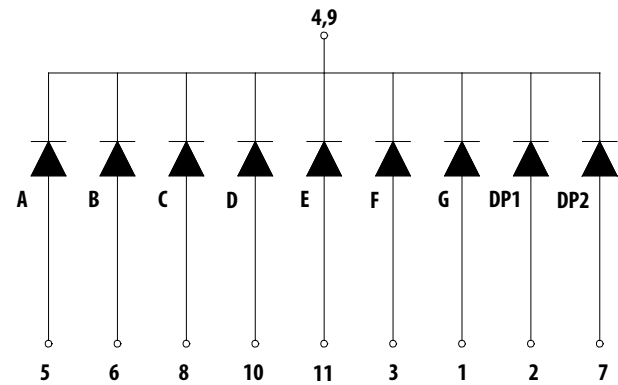
### Pin Connection (Common Cathode)

Pin Number	Connection
1	ANODE G
2	ANODE DP1
3	ANODE F
4	COMMON CATHODE
5	ANODE A
6	ANODE B
7	ANODE DP2
8	ANODE C
9	COMMON CATHODE
10	ANODE D
11	ANODE E

### Internal Circuit Diagram (Common Anode)



### Internal Circuit Diagram (Common Cathode)



### Absolute Maximum Ratings at $T_A = 25^\circ\text{C}$

Parameter	Green/Yellow/Red/Orange	Units
Power Dissipation Per Segment	65	mW
Peak Forward Current Per Segment (1/10 Duty Cycle, 0.1-ms pulse width)	100	mA
Continuous Forward Current Per Segment	25	mA
Derating Linearly From 25°C Per Segment	0.25	mA/°C
Reverse Voltage Per Segment	5	V
Operating Temperature Range	-40°C to +105°C	
Storage Temperature Range	-40°C to +105°C	

## Electrical/Optical Characteristics at $T_A = 25^\circ\text{C}$

### Green

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Condition
Average Luminous Intensity	$I_V$	3.4	6	—	mcd	$I_F = 10\text{ mA}$
Emissions Wavelength	$\lambda_p/\lambda_d$	—	572/571	—	nm	$I_F = 20\text{ mA}$
Spectral Line Half-Width	$\Delta\lambda$	—	20	—	nm	$I_F = 20\text{ mA}$
Forward Voltage, Per Segment	$V_F$	—	2.1	2.6	V	$I_F = 20\text{ mA}$
Reverse Current, Per Segment	$I_R$	—	—	100	$\mu\text{A}$	$V_R = 5\text{V}$
Luminous Intensity Matching Ratio	$I_{V-M}$	—	—	2:1		$I_F = 10\text{ mA}$

### Yellow

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Condition
Average Luminous Intensity	$I_V$	3.4	8.0	—	mcd	$I_F = 10\text{ mA}$
Emissions Wavelength	$\lambda_p/\lambda_d$	—	591/589	—	nm	$I_F = 20\text{ mA}$
Spectral Line Half-Width	$\Delta\lambda$	—	15	—	nm	$I_F = 20\text{ mA}$
Forward Voltage, Per Segment	$V_F$	—	2.1	2.6	V	$I_F = 20\text{ mA}$
Reverse Current, Per Segment	$I_R$	—	—	100	$\mu\text{A}$	$V_R = 5\text{V}$
Luminous Intensity Matching Ratio	$I_{V-M}$	—	—	2:1		$I_F = 10\text{ mA}$

### Red

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Condition
Average Luminous Intensity	$I_V$	3.4	7.5	—	mcd	$I_F = 10\text{ mA}$
Emissions Wavelength	$\lambda_p/\lambda_d$	—	644/630	—	nm	$I_F = 20\text{ mA}$
Spectral Line Half-Width	$\Delta\lambda$	—	20	—	nm	$I_F = 20\text{ mA}$
Forward Voltage, Per Segment	$V_F$	—	2.0	2.6	V	$I_F = 20\text{ mA}$
Reverse Current, Per Segment	$I_R$	—	—	100	$\mu\text{A}$	$V_R = 5\text{V}$
Luminous Intensity Matching Ratio	$I_{V-M}$	—	—	2:1		$I_F = 10\text{ mA}$

### Orange

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Condition
Average Luminous Intensity	$I_V$	3.4	8.5	—	mcd	$I_F = 10\text{ mA}$
Emissions Wavelength	$\lambda_p/\lambda_d$	—	611/605	—	nm	$I_F = 20\text{ mA}$
Spectral Line Half-Width	$\Delta\lambda$	—	20	—	nm	$I_F = 20\text{ mA}$
Forward Voltage, Per Segment	$V_F$	—	2.1	2.6	V	$I_F = 20\text{ mA}$
Reverse Current, Per Segment	$I_R$	—	—	100	$\mu\text{A}$	$V_R = 5\text{V}$
Luminous Intensity Matching Ratio	$I_{V-M}$	—	—	2:1		$I_F = 10\text{ mA}$

# Typical Electrical/Optical Characteristic Curves at $T_A = 25^\circ\text{C}$

## Green

Figure 1: Relative Luminous Intensity vs. Wavelength

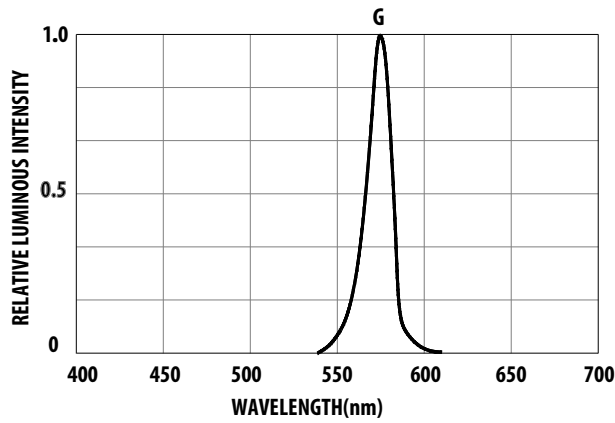


Figure 2: Relative Luminous Intensity vs. Forward Current

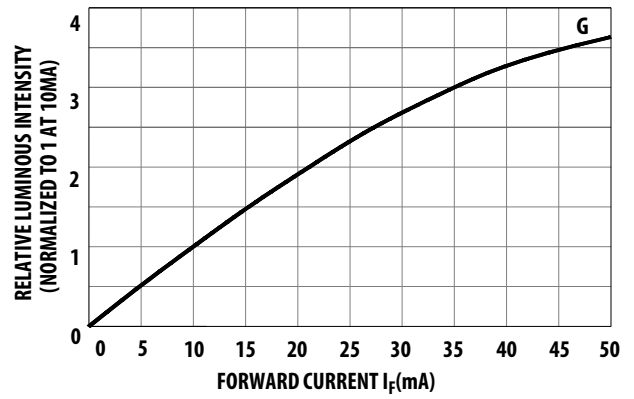


Figure 3: Allowable DC Current vs. Ambient Temperature

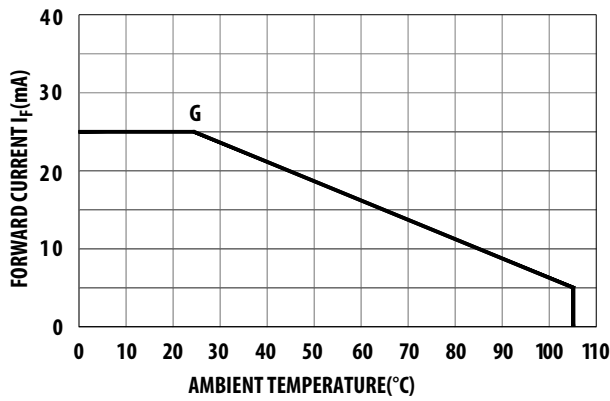
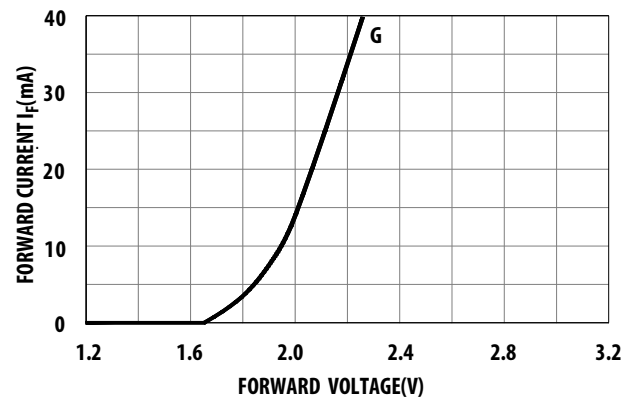


Figure 4: Forward Current vs. Forward Voltage



# Typical Electrical/Optical Characteristic Curves at $T_A = 25^\circ\text{C}$

## Yellow

Figure 5: Relative Intensity vs. Wavelength

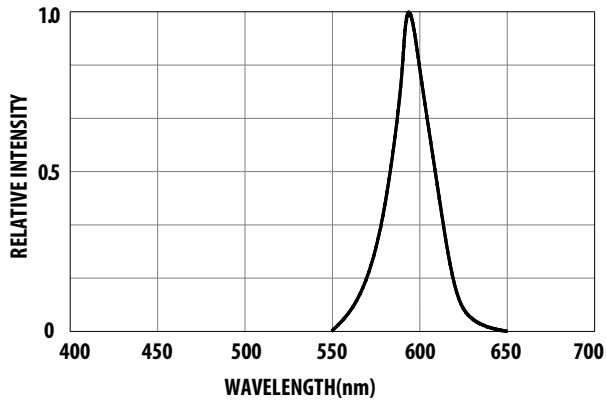


Figure 6: Relative Intensity vs. Forward Current

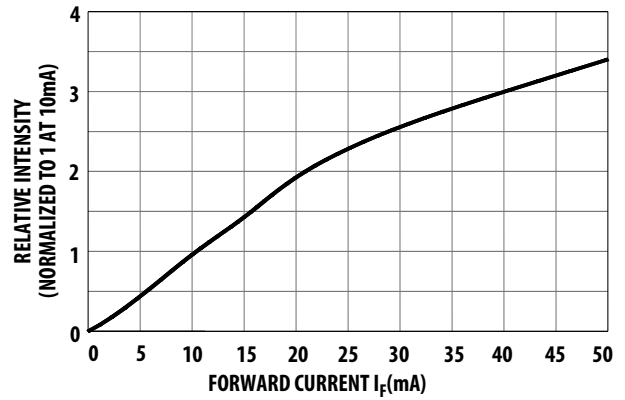


Figure 7: Allowable DC Current vs. Ambient Temperature

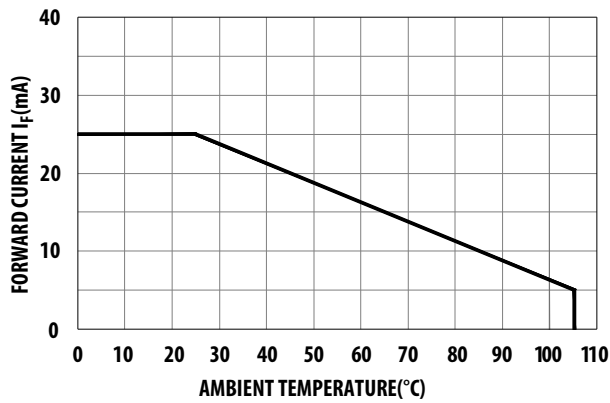
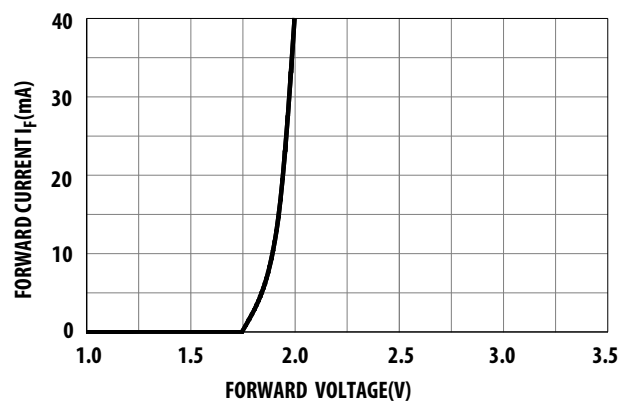


Figure 8: Forward Current vs. Forward Voltage



# Typical Electrical/Optical Characteristic Curves at $T_A = 25^\circ\text{C}$

## Red

Figure 9: Relative Intensity vs. Wavelength

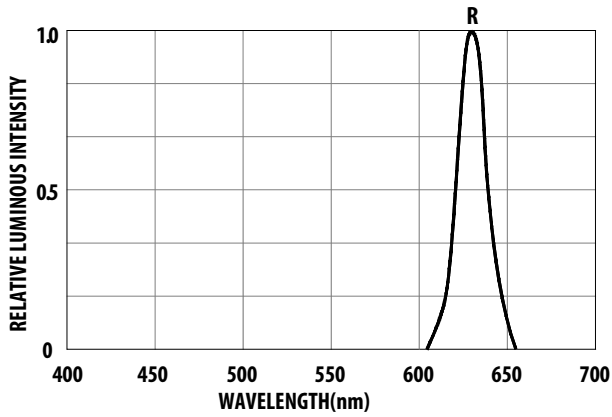


Figure 10: Relative Luminous Intensity vs. Forward Current

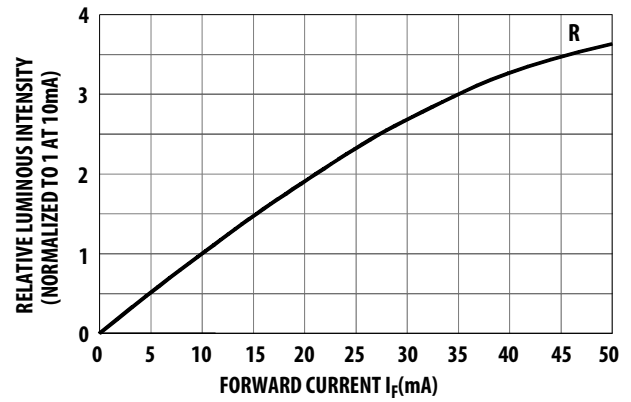


Figure 11: Allowable DC Current vs. Ambient Temperature

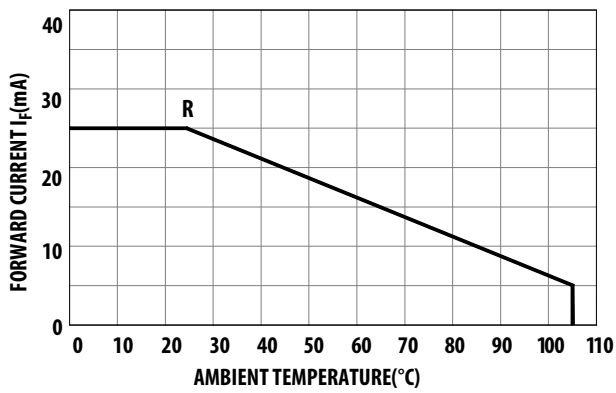
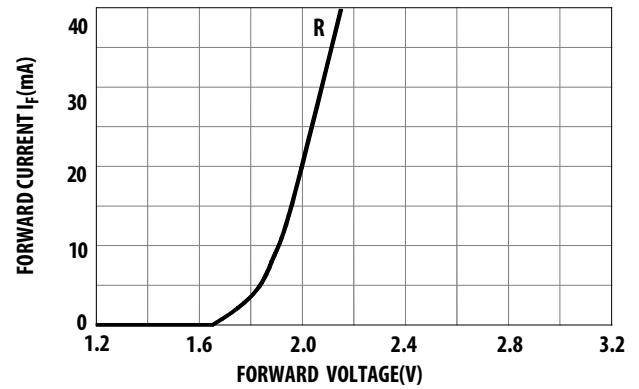


Figure 12: Forward Current vs. Forward Voltage



# Typical Electrical/Optical Characteristic Curves at $T_A = 25^\circ\text{C}$

## Orange

Figure 13: Relative Intensity vs. Wavelength

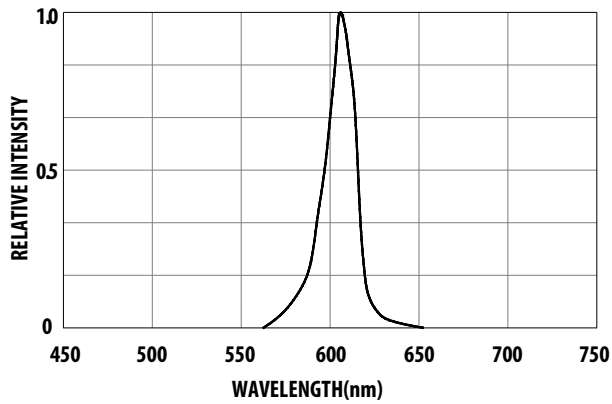


Figure 14: Relative Intensity vs. Forward Current

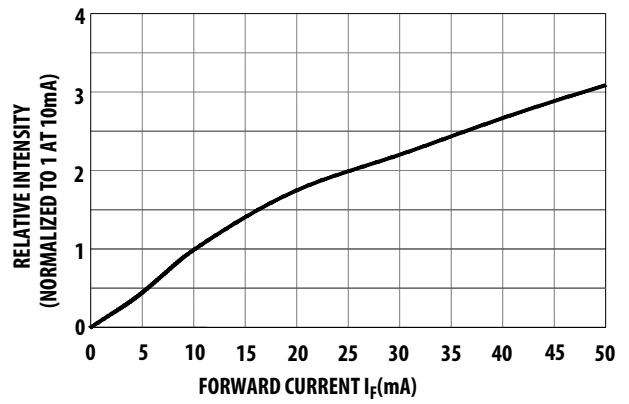


Figure 15: Allowable DC Current vs. Ambient Temperature

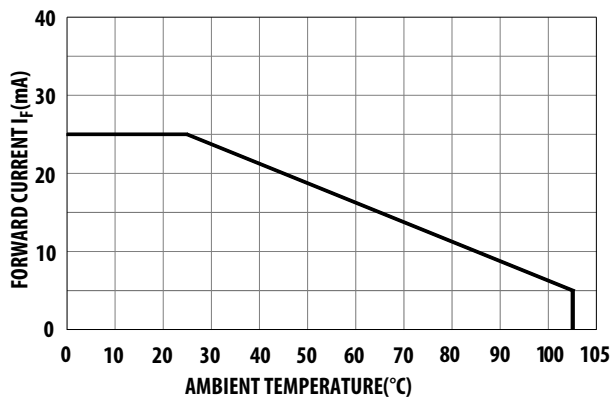
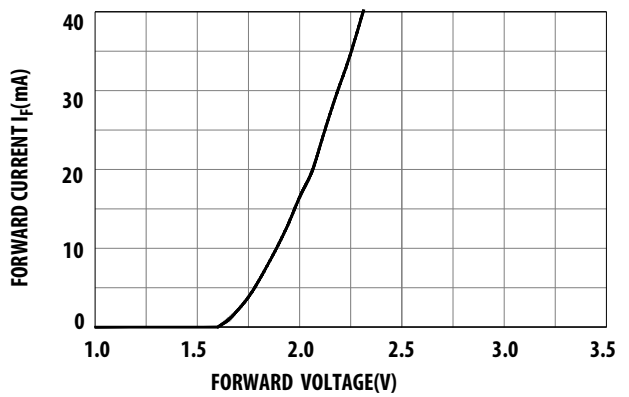


Figure 16: Forward Current vs. Forward Voltage





# Intensity Bin Limits (mcd)

## Yellow/Red/Orange/Green

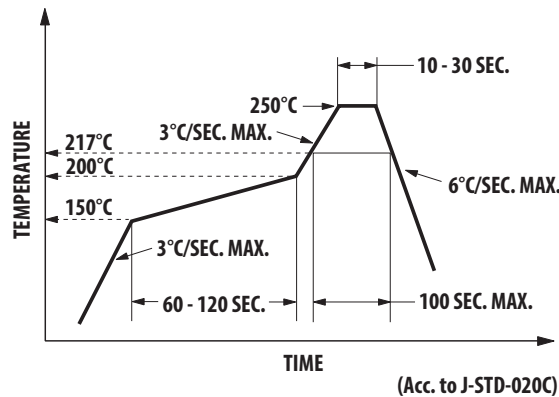
IV Bin Category	Min.	Max.
L	3.401	5.400
M	5.401	8.600
N	8.601	13.700
P	13.701	21.800

Tolerance: ± 15%.

**NOTE:** Bin categories are established for classification of products. Products may not be available in all categories. Contact your Broadcom representative for information on currently available bins.

## SMT Soldering Profile

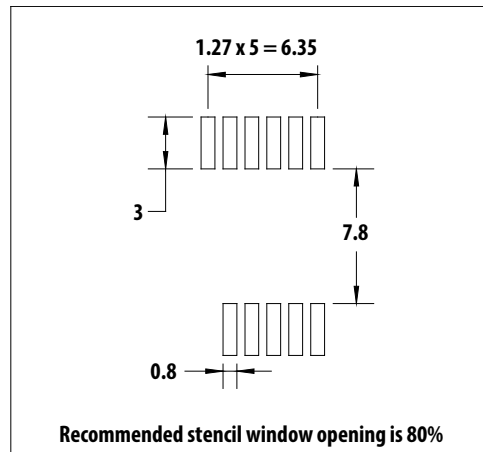
### Pb-Free Reflow Soldering Profile



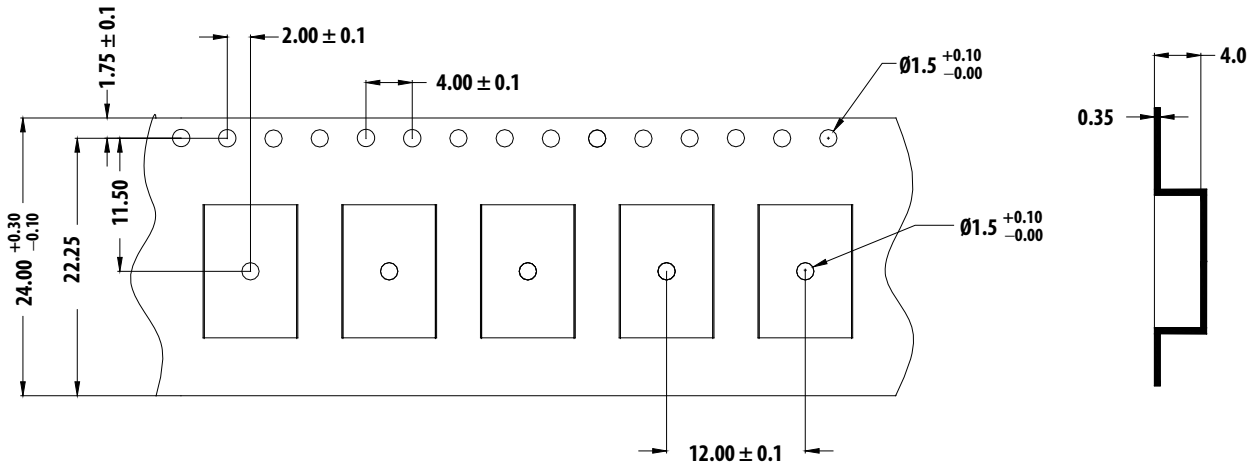
**NOTE:**

1. The peak temperature refers to the peak package body temperature.
2. The number of reflow processes shall be limited to a maximum of twice only. A cooling process to normal temperature is required between the first and second soldering processes.

### Recommended Soldering Pattern (Unit: mm)



# Tape Specification (Unit: mm)



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- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Доставку товара в любую точку России и стран СНГ.
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- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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